



AO4815

Dual P-Channel Enhancement Mode Field Effect Transistor

General Description

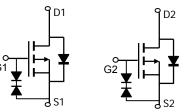
The AO4815 uses advanced trench technology to provide excellent $R_{DS(ON)}$, and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. The device is ESD protected. *Standard Product AO4815 is Pb-free (meets ROHS & Sony 259 specifications). AO4815L is a Green Product ordering option. AO4815 and AO4815L are electrically identical.*

Features

$$\begin{split} &V_{DS} (V) = -30V \\ &I_{D} = -8A \ (V_{GS} = -20V) \\ &R_{DS(ON)} < 18m\Omega \ (V_{GS} = -20V) \\ &R_{DS(ON)} < 20m\Omega \ (V_{GS} = -10V) \\ &ESD \ Rating: 2KV \ HBM \end{split}$$

1	8 🗖 D2
2	7 🗖 D2
3	6 🗖 D1
4	5 🗖 D1
	1 2 3 4

SOIC-8



Absolute Maximum Ratings T _A =25°C unless otherwise noted						
Parameter		Symbol	Maximum	Units		
Drain-Source Voltage		V _{DS}	-30	V		
Gate-Source Voltage	9	V _{GS}	±25	V		
Continuous Drain	T _A =25°C		-8			
Current ^A	T _A =70°C	I _D	-6.9	А		
Pulsed Drain Current ^B		I _{DM}	-40			
	T _A =25°C	D	2	W		
Power Dissipation ^A	T _A =70°C	- P _D	1.44	v		
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C		

Thermal Characteristics						
Parameter		Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient A	t ≤ 10s	- R _{0JA}	50	62.5	°C/W	
Maximum Junction-to-Ambient ^A	Steady-State	κ _θ ja	73	110	°C/W	
Maximum Junction-to-Lead ^C	Steady-State	$R_{ ext{ hetaJL}}$	31	40	°C/W	

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC I	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V		-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V				-1	μA
			TJ=55°C			-5	μA
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±25V				±1	μA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$		-1	-2.8	-3	V
I _{D(ON)}	On state drain current	V _{GS} =-10V, V _{DS} =-5V		-40			А
		V _{GS} =-20V, I _D =-8A			14.1	18	mΩ
R _{DS(ON)}	Static Drain-Source On-Resistance		T _J =125°C		19	24	
		V _{GS} =-10V, I _D =-8A			16.2	20	mΩ
		V_{GS} =-4.5V, I _D =-5A		37		mΩ	
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-8A			15		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V				-1	V
ls	Maximum Body-Diode Continuous Cur	irrent				-2.6	А
DYNAMI	C PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz			2330	2900	pF
C _{oss}	Output Capacitance				480		pF
C _{rss}	Reverse Transfer Capacitance				320		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			6.8	10	Ω
SWITCH	NG PARAMETERS						
Qg	Total Gate Charge	V _{GS} =-10V, V _{DS} =-15V, I _D =-8A			41	52	nC
Q_gs	Gate Source Charge				10		nC
Q_{gd}	Gate Drain Charge				12		nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =-10V, V _{DS} =-15V, R _L =1.8Ω, R _{GEN} =3Ω			13		ns
t _r	Turn-On Rise Time				12		ns
t _{D(off)}	Turn-Off DelayTime				51		ns
t _f	Turn-Off Fall Time				30.5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-8A, dI/dt=100A/μs			28	35	ns
Q _{rr}	Body Diode Reverse Recovery Charge	ge I _F =-8A, dI/dt=100A/μs			20.5		nC

A: The value of R_{aJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}$ C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

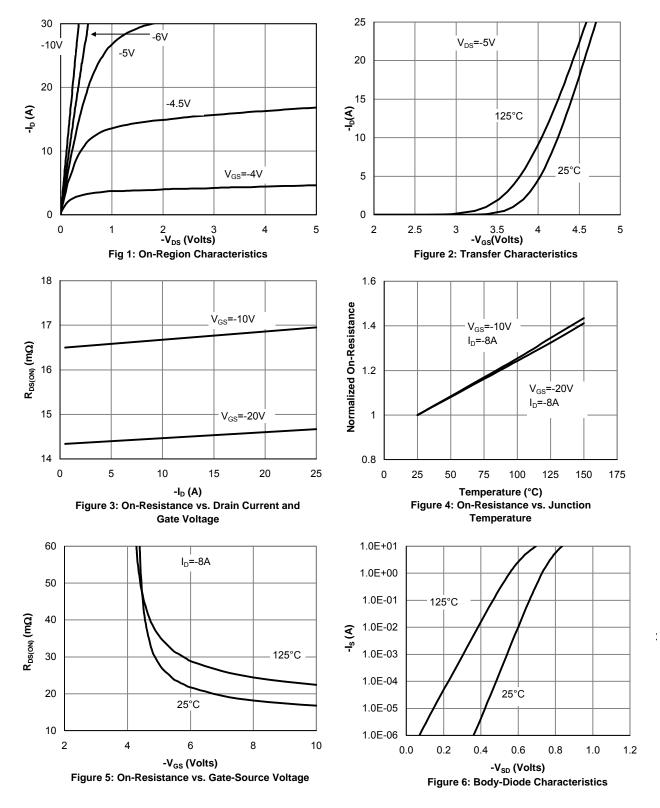
C. The R $_{\rm \theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\rm \theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using $80\mu s$ pulses, duty cycle 0.5% max.

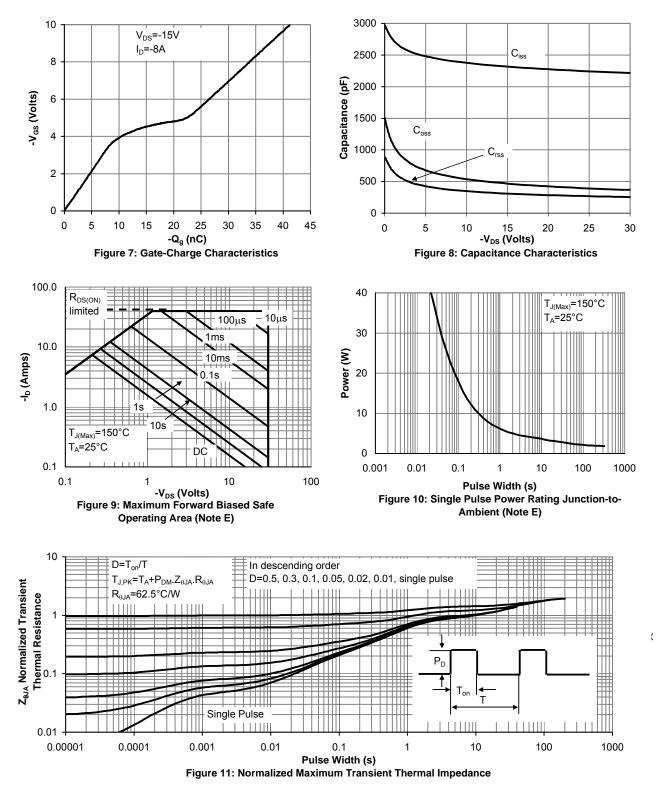
E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

Rev 2: Aug 2005

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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Alpha & Omega Semiconductor, Ltd.